

STYCAST 2651 W1

July 2019

PRODUCT DESCRIPTION

LOCTITE STYCAST 2651 W1 provides the following product characteristics:

Technology	Ероху		
Appearance (Resin)	Black		
Product Benefits	General purpose		
	 Low temperature cure 		
	Flexible processing		
	 Low coefficient of thermal 		
	expansion		
Cure	Room temperature or Heat cure		
Application	Encapsulation, Potting		
Key Substrates	Metals, Plastics and Ceramics		

LOCTITE STYCAST 2651 W1 is a dielectric grade epoxy encapsulant designed for general purpose applications and has excellent adhesion to a wide variety of substrates.

LOCTITE STYCAST 2651 W1 can be used with a variety of catalysts. For more information on mixed properties when used with other available catalysts, please contact your local technical service representative for assistance and recommendations.

GENERAL INSTRUCTIONS

Thoroughly read the information concerning Health and Safety contained iin this bulletin before using.

Observe all precautionary statements that appear on the product label and / or contained in individual Material Safety Data Sheets (MSDS).

To ensure long term performance of the potted or encapsulated electrical / electronic assembly, complete cleaning of components and substrates should be performed to remove contamination such as dust, moisture, salt and oils which can cause electrical failure, poor adhesion or corrosion in an embedded part.

CATALYST DESCRIPTION

LOCTITE CAT 9 provides, the following product characteristics

L	LOCTITE CAT 9 provides the following product characteristics:				
	Product Benefits	General purpose			
		 Good chemical resistance 			
		 Good physical strength 			
	Cure	Room temperature cure			



LOCTITE CAT 23LV provides the following product characteristics:

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Product Benefits	Low colour
	Low viscosity
	 Excellent thermal shock and impact resistance
	 Excellent adhesion to Glass
Cure	Room temperature cure

LOCTITE CAT 24LV provides the following product characteristics:

Product Benefits	 Low colour Low viscosity Excellent thermal shock and impact resistance Excellent adhesion to Glass
Cure	Room temperature cure



LOCTITE CAT 27-1 provides the following product characteristics:

Product Benefits	Long pot life
	 Excellent chemical resistance
	 Good physical and chemical properties at elevated
	temperatures
Cure	Heat cure

TYPICAL UNCURED PROPERTIES LOCTITE STYCAST 2651 W1

Viscosity, Brookfield , 25 °C, mPa·s (cP): 225,000

Density @ °C, g/cm³ 1.59

Shelf Life @ 18 to 25 °C 365

(from date of manufacture), days

Flash Point - See SDS

LOCTITE STYCAST 2651 W1 with LOCTITE CAT 9

Viscosity @ 25 °C, mPa·s (cP) 90 Density, g/cm³ 1

LOCTITE STYCAST 2651 W1 with LOCTITE CAT 23LV

Viscosity @ 25 °C, mPa s (cP) 9
Density, g/cm³ 1.5

LOCTITE STYCAST 2651 W1 with LOCTITE CAT 24LV

Viscosity @ 25 °C, mPa·s (cP) 15 Density, g/cm³ 1.05

LOCTITE STYCAST 2651 W1 with LOCTITE CAT 27-1

Viscosity @ 25 °C, mPa·s (cP) 275 Density, g/cm³ 1.05

TYPICAL UNCURED PROPERTIES AS MIXED LOCTITE STYCAST 2651 W1 with LOCTITE CAT 9

Mix Ratio, Material:Catalyst:

By Weight

By Volume

100:7

100: 11.5

Work Life, 100 grams @ 25 °C, minutes

Flash Point - See SDS

LOCTITE STYCAST 2651 W1 with LOCTITE CAT 23LV

Mix Ratio, Material:Catalyst:

By Weight

By Volume

100 :15

100 :24

Work Life, 100 grams @ 25 °C, minutes

Flash Point - See SDS

LOCTITE STYCAST 2651 W1 with LOCTITE CAT 24LV

Mix Ratio, Material:Catalyst:

By Weight

By Volume

100:15

100:15

Work Life, 100 grams @ 25 °C, minutes

Flash Point - See SDS

LOCTITE STYCAST 2651 W1 with LOCTITE CAT 27-1

Mix Ratio, Material:Catalyst:

 By Weight
 100:12

 By Volume
 100 : 18.5

 Work Life, 100 grams @ 25 °C, hours
 2

Flash Point - See SDS

TYPICAL CURING PERFORMANCE Cure Schedule

LOCTITE STYCAST 2651 W1 with LOCTITE CAT 9

16 to 24 hours @ 25°C or 4 to 6 hours @ 45°C or 1 to 2 hours @ 65°C

LOCTITE STYCAST 2651 W1 with LOCTITE CAT 23LV

24 hours @ 25°C or 4 to 6 hours @ 45°C or 2 to 4 hours @ 65°C

LOCTITE STYCAST 2651 W1 with LOCTITE CAT 24LV

24 hours @ 25°C or 4 to 6 hours @ 45°C or 2 to 4 hours @ 65°C

LOCTITE STYCAST 2651 W1 with LOCTITE CAT 27-1

4 hours @ 120°C

Cure at any one of the recommended cure schedules. For optimum performance, follow the initial cure with a post cure of 4 to 6 hours at the highest expected use temperature.

The above cure profiles are guideline recommendations. Cure conditions (time and temperature) may vary based on customers' experience and their application requirements, as well as customer curing equipment, oven loading and actual oven temperatures.

TYPICAL PROPERTIES OF CURED MATERIAL LOCTITE STYCAST 2651 W1 with LOCTITE CAT 9

Physical Properties Hardness. Shore D 92 Glass Transition Temperature, °C: (Tg) by TMA 107 (Tg) by DMA 107 Coefficient of Thermal Expansion ppm/°C: Below Ta 40 Above Tg 137 Weight Loss, %: 80.0 @150°C

@250°C	0.3
@300°C	0.51
@700°C	49.5
Thermal Conductivity , W/(m-K)	0.58
Linear Shrinkage, %	0.67

0.17

Water Absorption, %:

After 1 day @ 25°C , %

After 7 days @ 25°C , %

Operating temperature, °C

0.02

120 - 150

Storage Modulus:

@200°C

@ 35°C N/mm² 5,700 (psi) (827,000)

			LOCTITE STYCAST 2651 W1 with L	OCTITE C	AT 27-1
@ 50°C	N/mm²	5,500	Physical Properties	001112	A1 21-1
	(psi)	(798,000)	Hardness, Shore D		93
@ 100°C	N/mm²	770	Glass Transition Temperature, °C:		
@ 150°C	(psi) N/mm²	(112,000)	(Tg) by TMA		142
@ 150°C	(psi)	130 (18,900)	(Tg) by DMA		141
	(þsi)	(10,900)	Coefficient of Thermal Expansion :		
Floatrical Proportica			Below Tg		54
Electrical Properties Surface Resistivity, ohm		3.3×10¹⁵	Above Tg		144
Volume Resistivity, ohm-cm		1.8×10 ¹⁵	•		
volume Resistivity, onin-cm		1.0^10	Weight Loss, %:		
Dielectric Constant / Dissipation Fact	or.		@150°C		0.06
@ 50 Hz	.01.	5.0/0.061	@200°C		0.14
@ 1 kHz		4.8/0.048	@250°C		0.26
@ 1 MHz		4.0/0.031	@300°C		0.4
@ 1 Wil 12		4.0/0.001	@700°C		51.0
LOCTITE STYCAST 2651 W1 with LO	CTITE CA	AT 24LV	Thermal Conductivity , W/(m-K)		0.64
Physical Properties	, c <u>-</u> c,		Linear Shrinkage, %		0.73
Hardness, Shore D		92	Water Absorption, %:		
Glass Transition Temperature, °C:		-	After 1 day @ 25°C		0.03
(Tg) by TMA		69	After 7 days @ 25°C		0.1
(Tg) by DMA		78	Operating temperature, °C		175-200
Coefficient of Thermal Expansion :		. •	Storage Modulus:		
Below Tg		70	@ 35°C	N/mm²	4,000
Above Tg		151		(psi)	(580,000)
Weight Loss, %:		-	@ 50°C	N/mm²	3,900
@150°C		0.15		(psi)	(566,000)
@200°C		0.24	@ 100°C	N/mm²	
@250°C		0.35	0.45000	(psi)	(519,000)
@300°C		0.5	@ 150°C	N/mm²	
@700°C		48		(psi)	(16,700)
The arms of Council section in a NAVI and ICO		0.04	Electrical Properties		
Thermal Conductivity , W/(m-K)		0.61 0.78	Surface Resistivity		5.6×10 ¹⁵
Linear Shrinkage, %		0.76	Volume Resistivity,		2.2×10 ¹⁵
Water Absorption, %: After 1 day @ 25°C		0.05	Dielectric Constant / Dissipation Fac	rtor ·	2.2 10
After 7 days @ 25°C		0.05	@ 50 Hz		5.3/0.05
Operating temperature, °C		90-120	@ 1 kHz		5.1/0.045
Storage Modulus:		90-120	@ 1 MHz		4.2/0.04
•	N/mm²	4,170	© 1 Wii 12		1.2/0.01
@ 35°C		(605,000)			
@ 50°C	N/mm²	3,900	GENERAL INFORMATION		
@ 00 0		(566,000)	For safe handling information on the	nis produ	ct, consult the
@ 100°C	N/mm²	75	Safety Data Sheet, (SDS).		
9 11		(10,900)	DIRECTIONS FOR USE		
@ 150°C		85	1. To ensure the long term perform	manaa a	f the netted or
	(psi)	(12,300)	encapsulated electrical / electror		
			cleaning of components and substra	ites shoul	d be performed
Electrical Properties			to remove contamination such as du		
Surface Resistivity, ohm		2.9×10 ¹⁵	which can cause electrical failure, po	or adhesi	on or corrosion
Volume Resistivity ohm-cm		1.3×10 ¹⁵	in an embedded part.		
Dielectric Constant / Dissipation Factor:			2. Some filler settling is common dur	ina shinni	ng and storage
@ 50 Hz		5.1/0.057	For this reason, it is recommended		
@ 1 kHz		5.1/0.048	shipping container be thoroughly m	ixed prior	to use. Power
@ 1 MHz		4.1/0.042	mixing is preferred to ensure homoge	eneous pro	oduct.

- Accurately weigh resin and hardener into a clean container in the recommended ratio. Weighing apparatus having an accuracy in proportion to the amounts being weighed should be used.
- 4. Blend components by hand, using a kneading motion, for 2 to 3 minutes. Scrape the bottom and sides of the mixing container frequently to produce a uniform mixture. If possible, power mix to an additional 2 to 3 minutes. Avoid high mixing speeds which could entrap excessive amounts of air or cause overheating of the mixture resulting in reduced working life.
- 5. To ensure a void-free embedment, vacuum de-airing should be used to remove any entrapped air introduced during the mixing operation. Vacuum de-air mixture at 1 to 5 mm mercury. The foam will rise several times the liquid height and then subside. Continue to vacuum de-airing until most of the bubbling has ceased. This usually requires 3 to 10 minutes.
- 6. To facilitate deairing, gentle warming will also help but working life will be shortened. Reduced viscosity provides easy air release upon standing for a few minutes.
- 7. Pour mixture into cavity or mold. Gentle warming of the mold or assembly reduces the viscosity. This improves the flow of the material into the unit having intricate shapes or tightly packed coils or components. Further vacuum deairing in the mold may be required for critical applications.
- 8. NOTE: During storage at room temperature for long periods, it is possible that the viscosity of can increase and may exceed its upper specification limit. The viscosity can be brought back to the normal level by moderate mixing.

STORAGE:

Store product in the unopened container in a dry location. Storage information may be indicated on the product container labeling.

Optimal Storage: 18 to 25 °C

Material removed from containers may be contaminated during use. Do not return product to the original container. Henkel Corporation cannot assume responsibility for product which has been contaminated or stored under conditions other than those previously indicated. If additional information is required, please contact your local Technical Service Center or Customer Service Representative.

Not for product specifications

The technical data contained herein are intended as reference only. Please contact your local quality department for assistance and recommendations on specifications for this product.

Disclaimer

Note

The information provided in this Technical Data Sheet (TDS) including the recommendations for use and application of the product are based on our knowledge and experience of the product as at the date of this TDS. The product can have a variety of different applications as well as differing application and working conditions in your environment that are beyond our control. Henkel is, therefore, not liable for the suitability of our product for the production processes and conditions in respect of which you use them, as well as the intended applications and results. We strongly recommend that you carry out your own prior trials to confirm such suitability of our product.

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